APPLICA	BLE STAN	DARD				_							
RATING	OPERATING TEMPERATURE RANGE OPERATING HUMIDITY RANGE		-40°C TO +	85°C (NOTE	E 1) <u>1</u>		PERATURE RANGE			-10°C TO + 60°C (NOTE 2)			
			400/ TO . 000/			STORAG HUMIDIT	_			40% TO + 70% (NO	TE 2)		
	VOLTAGE		250V AC					VOLTAGE		30V AC			
	CURRENT		AWG 22 TO 26 :	2A	UL · CSA RATING	_	CURREN	NT	AWG 22 :	2A	ı		
CONNENT		AWG 28 : 1A AWG 30 : 0.5A						OOKKENT	•	AWG 24 TO 28 :		ı	
			AWG 30				\Box			AWG 30 :	0. 5A	ı	
			TEOT	SPECI	FICAI	IONS	>		F0111	DEMENTO	T _{OT}	Ι , τ	
	EM RLICTION		TEST	METHOD				R	EQUI	REMENTS	QT	AT	
	CONSTRUCTION GENERAL EXAMINATION VIS		VISUALLY AND BY MEASURING INSTRUMENT.			AC	ACCORDING TO DRAWING.				X	X	
		CONFIRMED VISUALLY.				1				X	X		
ELECTR	IC CHARA	CTERIS	STICS			I							
CONTACT F	RESISTANCE	100mA	0mA (DC OR 1000 Hz).			30	30mΩ MAX.				X	T	
INSULATION RESISTANC		500V DC.				10	1000MΩ MIN.				X	1_	
VOLTAGE P		650V AC FOR 1 min.			NO	NO FLASHOVER OR BREAKDOWN.				X	1_		
MECHAN	NICAL CHA	RACT	ERISTICS								1	1	
	MECHANICAL OPERATION		50 TIMES INSERTIONS AND EXTRACTIONS.				① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	_	
			FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE						CAL	DISCONTINUITY OF	 		
SHOCK			, AT 2 h, FOR 3			_	1μs.		- CR	ACK OR LOOSENESS	X	+-	
OHOOK			IRECTIONS.	TOLOL TTIII	37(101111	10		PARTS.	-, OK	ACK OK LOOSENESS	X	_	
			ACTERISTI										
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 \rightarrow 5 TO 35 \rightarrow +85 \rightarrow 5 TO 35 °C TIME 30 \rightarrow 5 TO 15 \rightarrow 30 \rightarrow 5 TO15 min UNDER 5 CYCLES.			nin 2 3	INSI NO	ULATION	RES	TANCE: $30 \text{m}\Omega$ MAX. SISTANCE: $1000 \text{M}\Omega$ MIN ACK OR LOOSENESS	X	-		
DAMP HEAT (STEADY STATE)		EXPOSE	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			2	 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 500MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				X	_	
COUN	T DI	ESCRIPTION	ON OF REVISIONS DESIG		ESIGNE	GNED		CHECKED			ATE		
1		DIS	-H-008540		MI	I. SAKIMUF				HK. UMEHARA	1	02. 26	
								APPRO\	-	TS. SAKATA	+	12. 16	
							}	CHECK		TS. FUKUSHIMA	1	12. 15	
							DESIGNE			TH. YOSHIZAWA		12. 15	
							DRAWN		'N	YK. NAKATSU	1	12.09	
		est AT:Assurance Test X:Applicable Test				DRAWING							
		PECIFICATION SHEET				ART NO				DF11CZ-*DS-2V (52)		410	
		USE EI	OSE ELECTRIC CO., LTD.			CODE NO.		CL543			<u> </u>	1/2	

	SPECIFICATIO	NS		
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 250°C WITHIN 10 sec. MIN 230°C WITHIN 60 sec. 《PREHEATING AREA》 150 TO 180°C 90 TO 120 sec. PUT THROUGH IN REFROW FURNACE TWICE. LEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNECTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :290±10°C, SOLDERING TIME :3s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230±5°C FOR IN IMMERSION , DURATION, 3 s.	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	х	_

REMARKS

NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD,
AFTER PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM
STORAGE DURING TRANSPORTATION.

NOTE 3:THE TEMPERATURE PROFILE SHALL BE APPLIED WITHIN 168 HOURS AFTER OPENING MOISTURE-PROOF PACKAGING. WHEN 168 HOURS PASSED AFTER OPENING , APPLY THE BOTTOM REQUIREMENTS.

《REFLOW AREA》

MAX 240°C WITHIN 10 sec.
MIN 230°C WITHIN 60 sec.
《PREHEATING AREA》
150 TO 180°C 90 TO 120 s.

Unless otherwise specifid, refer to IEC 60512.

Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC4-328653-00			
HRS.	SPECIFICATION SHEET	PART NO.	DF11CZ-*DS-2V (52)				
1	HIROSE ELECTRIC CO., LTD.	CODE NO		CL543	4	2/2	